# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

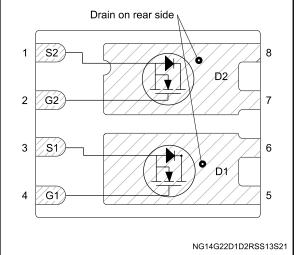




# Dual N-channel 60 V, 23 mΩ typ., 33 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 double island package

Datasheet - production data

# Image: state of the state



## Features

Order code	VDS	R <sub>DS(on)</sub> max	ID
STL36DN6F7	60 V	27 mΩ	33 A

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness

### **Applications**

• Switching applications

# Description

This dual N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

### Table 1: Device summary

Order code	Marking	Package	Packing
STL36DN6F7	36DN6F7	PowerFLAT™ 5x6 double island	Tape and reel

DocID028259 Rev 3

This is information on a product in full production.

### Contents

# Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	5
3	Test cir	cuits	7
4	Package	e information	8
	4.1	PowerFLAT 5x6 double island type C package information	9
	4.2	Packing information	12
5	Revisio	n history	14



# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V <sub>DS</sub>	Drain-source voltage	60	V	
V <sub>GS</sub>	Gate-source voltage	±20	V	
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at Tc = 25 °C	33	А	
ld <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	23	А	
ID <sup>(2)</sup>	Drain current (continuous) at T <sub>pcb</sub> = 25 °C	9	А	
ID <sup>(2)</sup>	Drain current (continuous) at T <sub>pcb</sub> =100°C	6.7	А	
I <sub>DM</sub> <sup>(1)(3)</sup>	Drain current (pulsed)	132	А	
I <sub>DM</sub> <sup>(2)(3)</sup>	Drain current (pulsed)	36	А	
Ртот <sup>(1)</sup>	Total dissipation at $T_C = 25 \ ^{\circ}C$	58	W	
Ртот <sup>(2)</sup>	Total dissipation at $T_{pcb} = 25^{\circ}C$	4.8	W	
TJ	Operating junction temperature range	EE to 17E	•0	
T <sub>stg</sub>	Storage temperature range	-55 to 175 °C		

### Notes:

 $^{(1)}\mbox{This}$  value is rated according to  $R_{\mbox{thj-c}}.$ 

 $^{(2)}\mbox{The}$  value is rated according to  $R_{\mbox{thj-pcb}}.$ 

 $^{\rm (3)}{\rm Pulse}$  width limited by safe operating area.

### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction- case	2.6	°C/W
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb	31.3	°C/W

### Notes:

 $^{(1)}$ When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t < 10 s.



# 2 Electrical characteristics

(Tc = 25 °C unless otherwise specified)

Table 4: On /off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	60			V
IDSS	Zero gate voltage drain current	$V_{\text{DS}} = 60 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{\text{DS}}=0~\text{V}~, V_{\text{GS}}=20~\text{V}$			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 V, I_D = 4.5 A$		23	27	mΩ

### Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance			420	-	pF
Coss	Output capacitance $V_{DS} = 30 \text{ V}, \text{ f} = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$		-	215	-	pF
Crss	Reverse transfer capacitance			16	-	pF
Qg	Total gate charge $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		-	8	-	nC
Qgs	Gate-source charge	$V_{GS} = 0$ to 10 V	-	2.3	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	2.1	-	nC

### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(on)	Turn-on delay time	$V_{DD} = 30 V, I_D = 4.5 A,$	-	7.85	-	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see <i>Figure 13: "Test circuit</i>	-	3.25	-	ns
t <sub>d(off)</sub>	Turn-off delay time	for resistive load switching	-	12.1	-	ns
tr	Fall time	times" and Figure 18: "Switching time waveform")	-	3.95	-	ns

### Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage I <sub>SD</sub> = 9 A, V <sub>GS</sub> = 0 V		-		1.2	V
trr	Reverse recovery time	$I_D = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	17.1		ns
Qrr	Reverse recovery charge	verse recovery charge V <sub>DD</sub> = 48 V		6.67		nC
IRRM	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	0.8		A

### Notes:

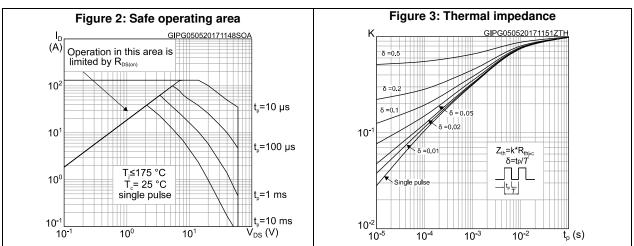
 $^{(1)}$ Pulsed: pulse duration = 300  $\mu s,$  duty cycle 1.5%.

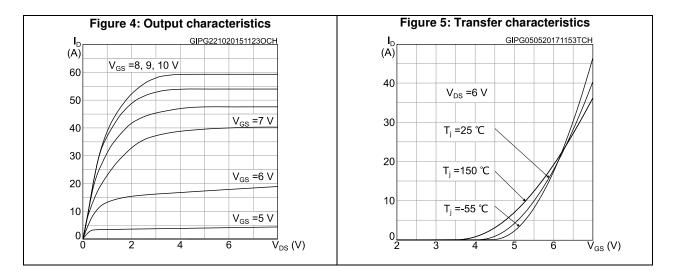


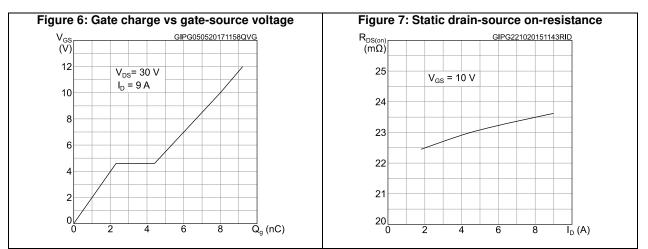


57

# 2.1 Electrical characteristics (curves)



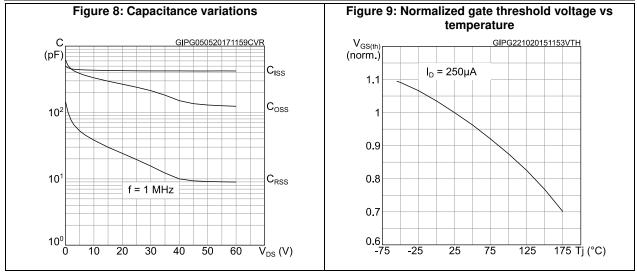


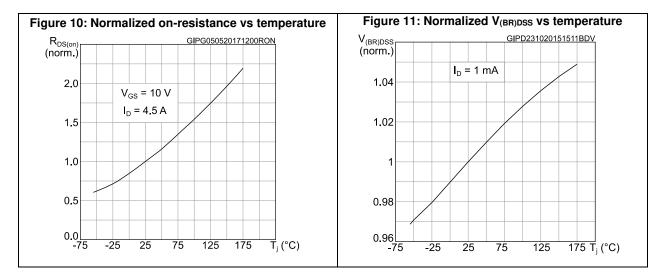


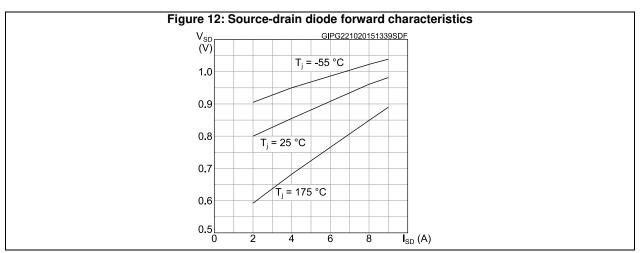
DocID028259 Rev 3

### **Electrical characteristics**

### STL36DN6F7



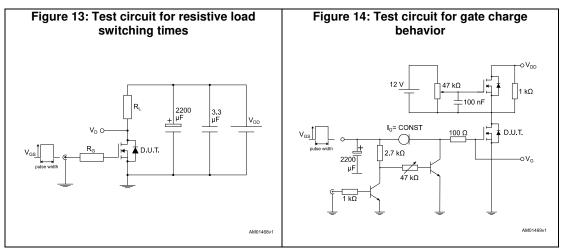


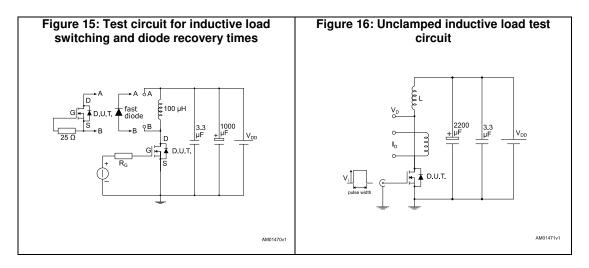


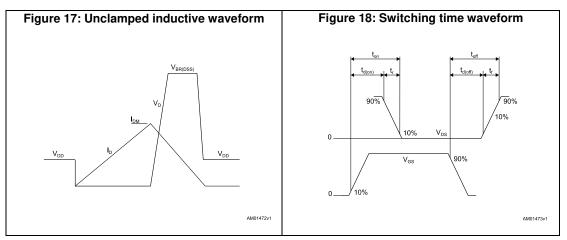
DocID028259 Rev 3



# 3 Test circuits









# 4 Package information

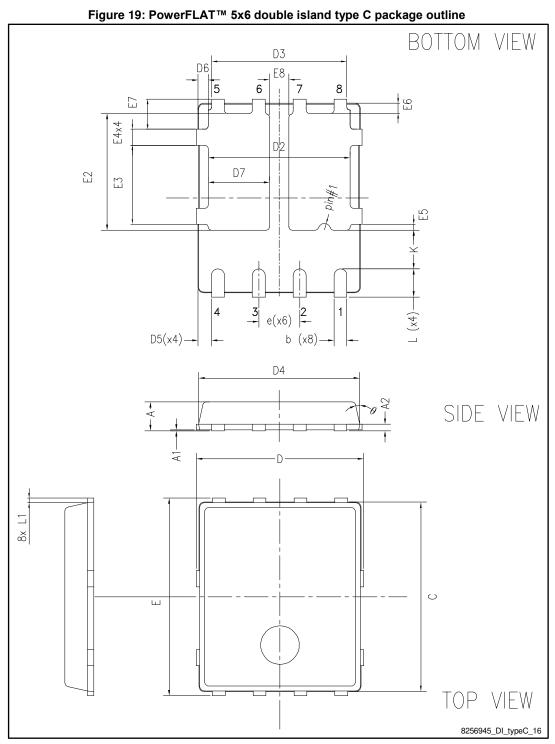
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

8/15



57

# 4.1 PowerFLAT 5x6 double island type C package information



DocID028259 Rev 3

### Package information

### STL36DN6F7

Table 8: PowerFLAT™ 5x6 double island type C mechanical data					
Dim.		mm			
Dini.	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.20		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.00	5.20		
D5	0.25	0.40	0.55		
D6	0.15	0.30	0.45		
D7	1.68		1.98		
е		1.27			
E	5.95	6.15	6.35		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.20	0.325	0.45		
E7	0.75	0.90	1.05		
E8	0.55		0.75		
К	1.05		1.35		
L	0.725		1.025		
L1	0.05	0.15	0.25		
θ	0°		12°		



Package information

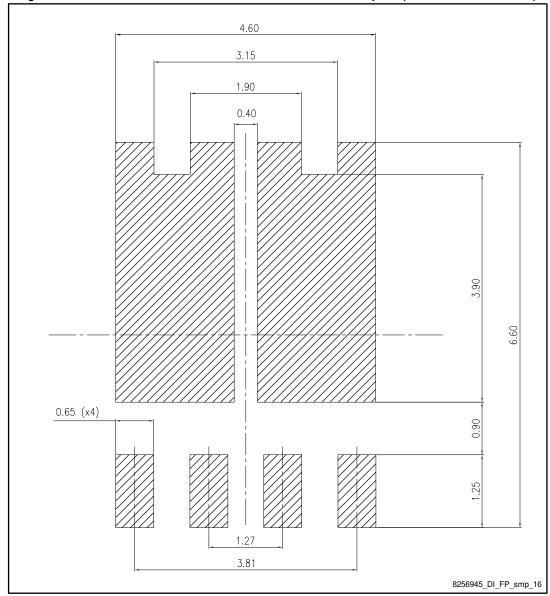
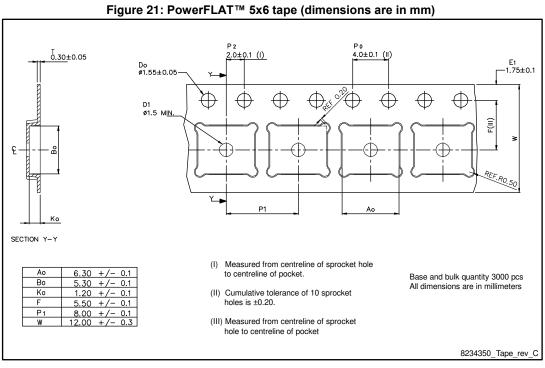


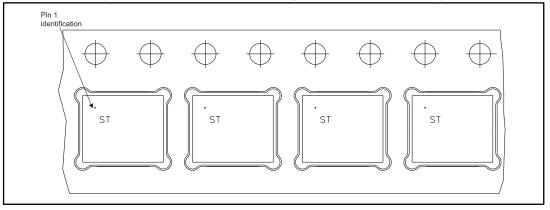
Figure 20: PowerFLAT™ 5x6 double island recommended footprint (dimensions are in mm)



# 4.2 Packing information

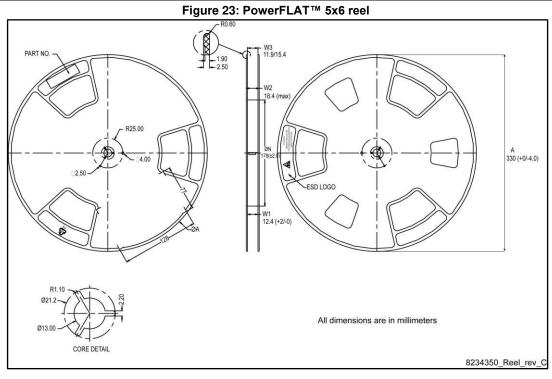








### Package information





# 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
20-Aug-2015	1	First release.
22-Oct-2015	2	Document status promoted from preliminary to production data. Updated Section 2: "Electrical ratings" and Section 3: "Electrical characteristics". Added Section 3.1: "Electrical characteristics (curves)".
10-May-2017	3	Modified title and features table on cover page. Modified Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "On /off states" Modified Figure 4: "Output characteristics", Figure 5: "Transfer characteristics", Figure 7: "Static drain-source on-resistance" and Figure 12: "Source-drain diode forward characteristics". Minor text changes.



### **IMPORTANT NOTICE – PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved

